

TK1362 - Koh Young KY8030-3 3D Solder Paste Inspection (2011)

Model: KY8030-3 3D Solder Paste Inspection

SKU:

Year: 2011



Description:

Koh Young Technology KY8030-3 3D Solder Paste Inspection (2011)

- Brand: Koh Young Technology
- Model: KY8030-3
- Serial Number: SPI-83L215
- Power: 220V a.c
- Year of Manufacture: 2011
- Type: 3D SPI

FEATURES:

- Inspection speed at 0.24sec/FOV
- 3D Shadow Free Moiré Technology & Dual Projection
- Multi Frequency Free Moiré Technology + Z Tracking
- Renewal GUI software
- 4M Pixel High Sppeed Camera
- Metrology Capability: Volume, Area, Height, Offset, Bridging, Shape Deformity, Coplanarity

- FOV (Field of View) Size: 40 x 40 mm (1.60 x 1.60 inch)
- Max. Paste Size: 0.3 x 0.30 inch
- Conveyor Width Adjustment: Automatic
- Conveyor Fix Type: Front/Rear Fixed

